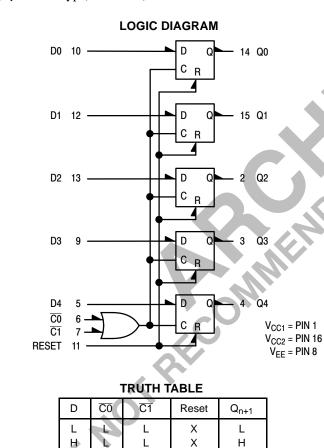
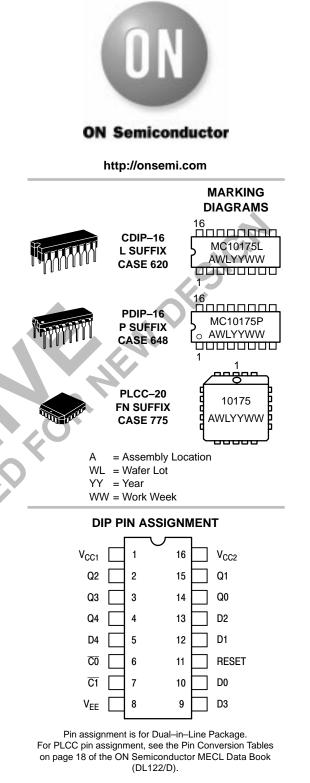
# **Quint Latch**

The MC10175 is a high speed, low power quint latch. It features five D type latches with common reset and a common two–input clock. Data is transferred on the negative edge of the clock and latched on the positive edge. The two clock inputs are "OR"ed together.

Any change on the data input will be reflected at the outputs while the clock is low. The outputs are latched on the positive transition of the clock. While the clock is in the high state, a change in the information present at the data inputs will not affect the output information. The reset input is enabled only when the clock is in the high state.

- $P_D = 400 \text{ mW typ/pkg}$  (No Load)
- $t_{pd} = 2.5$  ns typ (Data to Output)
- $t_r$ ,  $t_f = 2.0$  ns typ (20%-80%)





#### **ORDERING INFORMATION**

Device	Package	Shipping		
MC10175L	CDIP-16	25 Units / Rail		
MC10175P	PDIP-16	25 Units / Rail		
MC10175FN	PLCC-20	46 Units / Rail		

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#### **ELECTRICAL CHARACTERISTICS**

#### ELECTRICAL CHARACTERISTICS (continued)

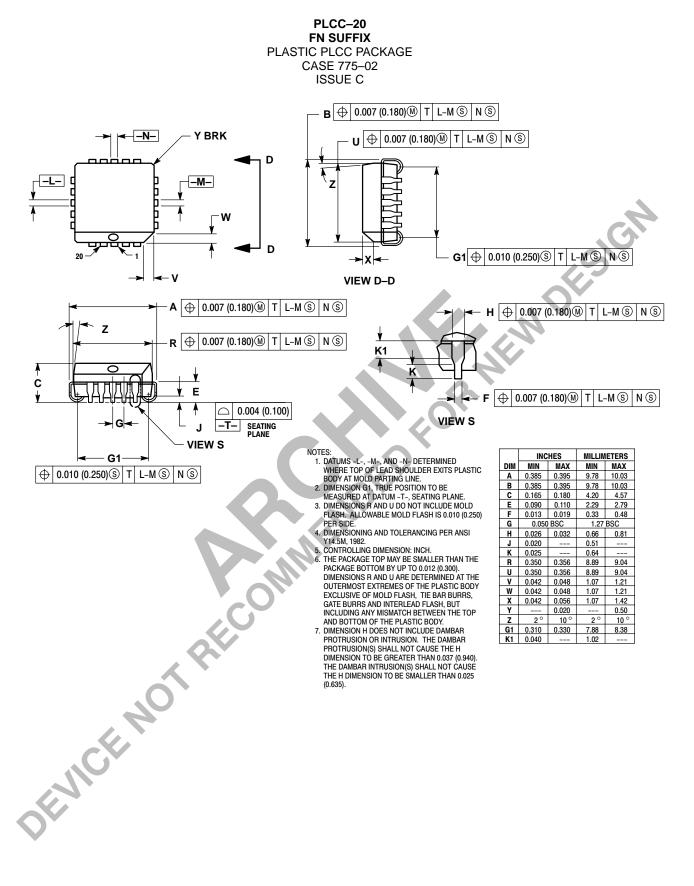
					TEST VOI	TAGE VALU	JES (Volts)		
		@ Test Te	mperature	V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmax</sub>	V <sub>EE</sub>	
			–30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
			Pin	TEST V	OLTAGE AP	PLIED TO PI	NS LISTED I	BELOW	
Characteristic		Symbol	Under Test	V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmax</sub>	V <sub>EE</sub>	(V <sub>CC</sub> ) Gnd
Power Supply Drain (	Current	ΙE	8					8	1, 16
Input Current		l <sub>inH</sub>	6 7 10 11	6 7 10 11				8 8 8 8	1, 16 1, 16 1, 16 1, 16
		I <sub>inL</sub>	All		Note 1.			8	1, 16
Output Voltage	Logic 1	V <sub>OH</sub>	14 15	10 12	6 6			8	1, 16 1, 16
Output Voltage	Logic 0	V <sub>OL</sub>	14 15		6, 10 6, 12			8 8	1, 16 1, 16
Threshold Voltage	Logic 1	V <sub>OHA</sub>	14 15		6 6	10 12		8 8	1, 16 1, 16
Threshold Voltage	Logic 0	V <sub>OLA</sub>	14 15		6 6		10 12	8 8	1, 16 1, 16
Switching Times	(50 $\Omega$ Load)			+1.11V	+0.31V	Pulse In	Pulse Out	–3.2 V	+2.0 V
	Data Input	t <sub>10+14+</sub> t <sub>10–14–</sub>	14 14		6, 7 6, 7	10 10	14 14	8 8	1, 16 1, 16
	Clock Input	t <sub>6–14+</sub> t <sub>6–14–</sub>	14 14		777	10, 6 10, 6	14 14	8 8	1, 16 1, 16
	Reset Input	t <sub>11+4–</sub> t <sub>11+14–</sub>	4 14	5 10	6 6	7, 11 7, 11	4 (2.) 14 (2.)	8 8	1, 16 1, 16
Setup TIme Hold Time		t <sub>setup</sub> t <sub>hold</sub>	14 14		7 7	6, 10 6, 10	14 14	8 8	1, 16 1, 16
Rise Time	(20 to 80%)	t+	14		6, 7	10	14	8	1, 16
Fall Time	(20 to 80%)	t–	14		6, 7	10	14	8	1, 16

1. Individually test each input; apply V<sub>ILmin</sub> to pin under test.

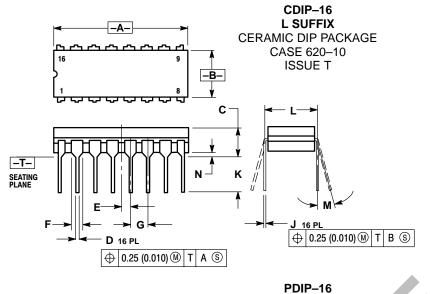
2. Output latched to high logic state prior to test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibitum has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

#### PACKAGE DIMENSIONS



#### PACKAGE DIMENSIONS



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLLING DIMENSION: INCH.
DIMENSION L TO CENTER OF LEAD WHEN FOOMED DRAWLES

DIMENSION LTO CENTER OF LEAD WHEN FORMED PARALLEL.
DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INC	HES	MILLIMETERS		
DIM	MIN MAX		MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050 BSC		1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100 BSC		2.54 BSC		
Н	0.008	0.015	0.21	0.38	
Κ	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62 BSC		
М	0 °	15 °	0 °	15°	
Ν	0.020	0.040	0.51	1.01	

-A-<u>ሳ ስ ስ ስ</u> 16 в 0 L  $\Box \Box$ ι, հո - C S -T- SEATING PLANE H G **D** 16 PL

**P SUFFIX** PLASTIC DIP PACKAGE CASE 648-08 ISSUE R

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH. 5. ROUNDED CORNERS OPTIONAL.

		INC	HES	MILLIMETERS		
D	MIM	MIN	MAX	MIN	MAX	
	Α	0.740	0.770	18.80	19.55	
	В	0.250	0.270	6.35	6.85	
1	C	0.145	0.175	3.69	4.44	
	D	0.015	0.021	0.39	0.53	
	F	0.040	0.70	1.02	1.77	
1	G	0.100	BSC	2.54 BSC		
	H	0.050	BSC	1.27 BSC		
	J	0.008	0.015	0.21	0.38	
	Κ	0.110	0.130	2.80	3.30	
	L	0.295	0.305	7.50	7.74	
	М	0°	10 °	0 °	10 °	
	S	0.020	0.040	0.51	1.01	

# **Notes**

# **Notes**

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